

Product / Process Change Notification



N° 2020-097A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an additional wafer production location at Infineon Technologies (Kulim) Sdn. Bhd., Malaysia for ISO1H801G, ISO1H811G, ISO1H812G, ISO1H815G, ISO1H816G

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **27. October 2020**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Dr. Wolfgang Eder
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider
Registered Office: Neubiberg
Commercial Register: München HRB 126492

Product / Process Change Notification



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► **Products affected:** Please refer to attached affected product list 1_cip20097_a

► **Detailed Change Information:**

Subject: Introduction of an additional wafer production location at Infineon Technologies (Kulim) Sdn. Bhd., Malaysia for ISO1H801G, ISO1H811G, ISO1H812G, ISO1H815G, ISO1H816G

Reason: Infineon internal second sourcing for capacity extension to assure continuity of supply and enable flexible manufacturing

Description:

Old

- Infineon Technologies AG
Regensburg, Germany

New

- Infineon Technologies AG
Regensburg, Germany
or
- Infineon Technologies (Kulim)
Sdn. Bhd., Kulim, Malaysia

► **Product Identification:** Internal traceability assured via Baunumber and datecode

► **Impact of Change:** No impact on parameters and reliability as proven via product qualification.

► **Attachments:**
1_cip20097_a: Affected product list
2_cip20097_a: Qualification report

► **Time Schedule:**

- Final qualification report: available
- First samples available: on request
- Intended start of delivery: 31-Dec -2020 or earlier, depending on customer approval

If you have any questions, please do not hesitate to contact your local Sales office.

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Malaysia for ISO1H801G, ISO1H811G, ISO1H812G, ISO1H815G, ISO1H816G



Sales name	SP number	OPN	Package
ISO1H801G	SP000722122	ISO1H801GAUMA1	PG-DSO-36
ISO1H811G	SP000413798	ISO1H811GAUMA1	PG-DSO-36
ISO1H812G	SP000413800	ISO1H812GAUMA1	PG-DSO-36
ISO1H815G	SP000555576	ISO1H815GAUMA1	PG-DSO-36
ISO1H816G	SP000555578	ISO1H816GAUMA1	PG-DSO-36